Display Elektronik GmbH

DATA SHEET

LCD MODULE

DEM 128128C SBH-PW-N

Product Specification

Ver.: 1

12/Dec./2009

DOCUMENT REVISION HISTORY

Version	DATE	DESCRIPTION	CHANGED BY
0	Oct-27-2009	First issue	MH
1	Dec-12-2009	Update Backlight characteristics	MH

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1. FUNCTIONS & FEATURES

Display-Format : 128 x 128 Dots

LCD Mode : STN-BLUE / Negative / Transmissive

Viewing Direction : 6 o'clock

Driving Scheme : 1/128 Duty cycle, 1/11 Bias

Power Supply Voltage (V_{DD}) : 3.3 Volt (typ.)

LCD Driving Voltage (V_{LCD}) : 12.0 Volt (Reference Voltage)

Operation Temperature : -20°C to +70°C Storage Temperature : -30°C to +80°C

Backlight : LED, White, Lightguide

RoHS : Compliant.

2. MECHANICAL SPECIFICATIONS

Module Size : 48.00 x 52.80 x 4.40 mm (without FPC)

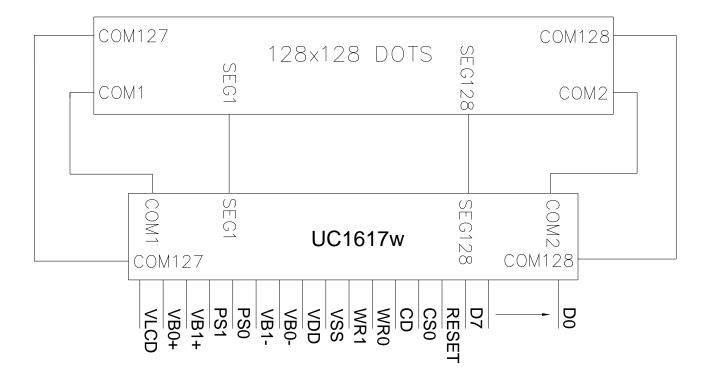
 Viewing Area
 : 44.00 x 40.50 mm

 Dot Pitch
 : 0.297 x 0.297 mm

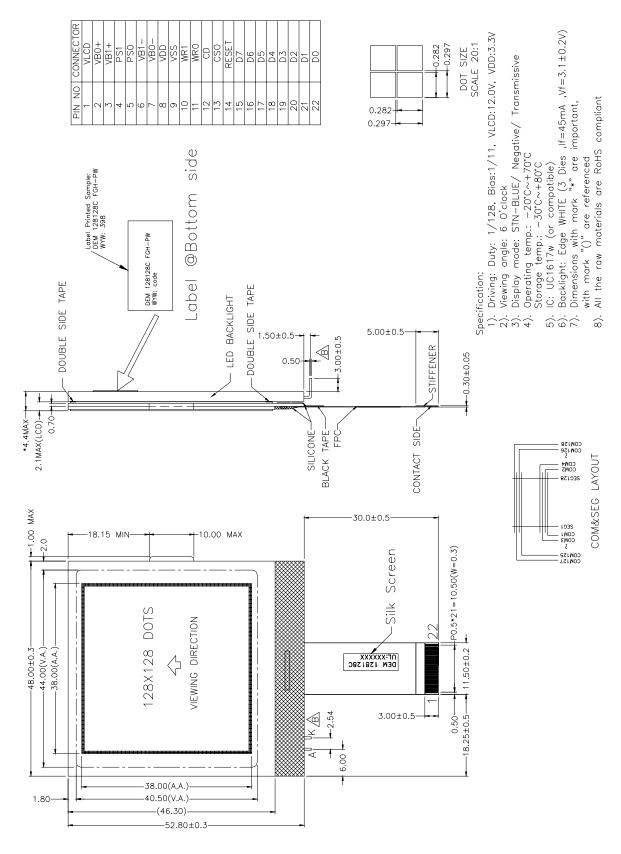
 Dot Size
 : 0.282 x 0.282 mm

 Dot Gap
 : 0.015 mm

3. BLOCK DIAGRAM



4. DIMENSIONAL OUTLINE



5. PIN DESCRIPTION

1	VLCD	High voltage LCD Power Supply									
2,3,	VB0+,VB1+,	LCD Bias Voltages									
6,7	VB1VB0-	202 2100 1 0110000									
		Bus mode: The interface bus mode is determined by BM[1:0] and D[7:6] by the following relationship:									
		BM[1:0] D[7:6] Mode									
		11 Data 6800/8-bit									
4,5	PS1 ,PS0	10 Data 8080/8-bit									
1,5	101,100	01 11 2-wire I ² C									
		00 10 4-wire SPI w/ 8-bit token (S8: conventional)									
		00 11 3-wire SPI w/ 8-bit token (S8uc: Ultra-Compact)									
8	VDD	Power supply for logic(+3.3V)									
9	VSS	Power ground(0V)									
10,11	WR1,WR0	WR[1:0] controls the read/write operation of the host interface.									
12	CD	Selects control data or display data for read/write operation "L": Control data; "H": Display data									
13	CS0	This is the chip select signal									
14	RESET	The RESET signal									
15~22	D7~D0	Parallel host interfaces.									

6. MAXIMUM ABSOLUTE LIMIT

Maximum Ratings (Voltage Reference to VSS)(for IC)

In accordance with IEC134, note 1 and 2.

Symbol	Parameter	Min.	Max.	Unit
V _{DD}	Logic Supply voltage	-0.3	+4.0	٧
V_{DD2}	LCD Generator Supply voltage	-0.3	+4.0	V
V _{DD3}	Analog Circuit Supply voltage	-0.3	+4.0	V
$V_{DD2/3}$ - V_{DD}	Voltage difference between V _{DD} and V _{DD2/3}		1.6	V
V _{LCD}	LCD Generated voltage (-30°C ~ +80°C)	-0.3	+19.8	V
V_{IN}	Digital input signal	-0.4	V _{DD} + 0.5	V
T _{OPR}	Operating temperature range	-30	+85	°C
T _{STR}	Storage temperature	-55	+125	°C

Notes

- 1. VDD is based on VSS = 0V
- 2. Stress beyond ranges listed above may cause permanent damages to the device.

7. ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

DC CHARACTERISTICS

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V_{DD}	Supply for digital circuit		1.65		3.45	V
$V_{DD2/3}$	Supply for bias & pump		2.5		3.45	V
V _{LCD}	Charge pump output	V _{DD2/3} ≥ 2.6V, 25 ^o C		14	15	V
V _D	LCD data voltage	V _{DD2/3} ≥ 2.6V, 25 ^o C	0.89		1.78	V
V _{IL}	Input logic LOW				0.2V _{DD}	V
V _{IH}	Input logic HIGH		0.8V _{DD}			V
VoL	Output logic LOW				0.2V _{DD}	V
V _{OH}	Output logic HIGH		0.8V _{DD}			V
I _{IL}	Input leakage current				1.5	μΑ
I _{SB}	Standby current	V _{DD} = V _{DD2/3} = 3.3V, Temp = 85 °C			50	μА
C _{IN}	Input capacitance			5	10	pF
C _{OUT}	Output capacitance			5	10	pF
R _{ON(SEG)}	SEG output impedance	V _{LCD} = 15V		1.5	2.0	kΩ
R _{DN(COM)}	COM output impedance	V _{LCD} = 15V		1.5	2.0	kΩ
f _{LINE}	Average Line rate	LC[4:3] = 10b	-10%	21.1	+10%	kHz

Power Consumption

 $V_{DD} = 2.7V$, Bias Ratio = 11. PM = 78,

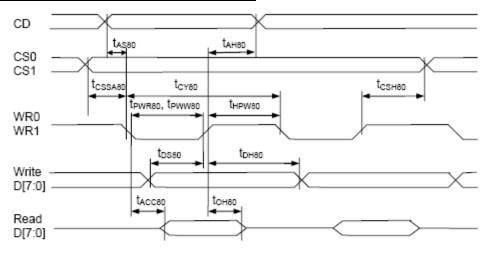
Panel Loading (PC[1:0]) = 10b, Line Rate = 10b,

V_{LCD} = 14V, Mux Rate = 128, Bus mode = 6800, $C_L = 330nF$, Temperature = 25°C, OTP=00H, $C_B = 2.2 \mu F$,

All HV outputs are open circuit.

Display Pattern	Conditions	Тур. (µА)	Max. (μA)
All-OFF	Bus = idle	576	806
2-pixel checker	Bus = idle	704	986
-	Bus = idle (standby current)	•	5

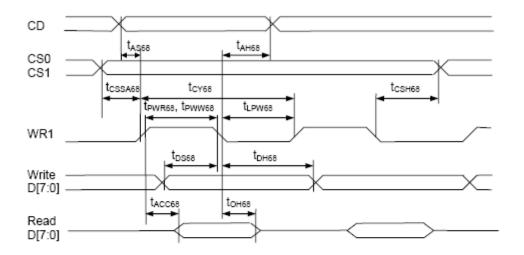
8. TIMING CHARACTERISTICS



Parallel Bus Timing Characteristics (for 8080 MCU)

 $(2.5V \le V_{DD} < 3.3V, Ta = -30 \text{ to } +85^{\circ}C)$

Symbol	Signal	Description	Condition	Min.	Max.	Units
taseo taheo	CD	Address setup time Address hold time		0 0	-	nS
t _{CY80}		System cycle time (read) (write)		170 130	ı	nS
t _{PWR80}	WR1	Pulse width (read)		85	ı	nS
t _{PWW80}	WR0	Pulse width (write)		65	-	nS
t _{HPW80}	WR0, WR1	High pulse width (read) (write)		85 65	1	nS
tosso tonso	D0~D7	Data setup time Data hold time		30 0	ı	nS
tacceo tohed		Read access time Output disable time	C _L = 100pF	1 1	65 30	nS
t _{cssaed} t _{csheo}	CS1/CS0	Chip select setup time Chip select hold time		5 5		nS



Parallel Bus Timing Characteristics (for 6800 MCU)

 $(2.5V \le V_{DD} < 3.3V, Ta = -30 \text{ to } +85^{\circ}C)$

Symbol	Signal	Description	Condition	Min.	Max.	Units
t _{ases} tahes	CD	Address setup time Address hold time		0 0	-	nS
t _{CY68}		System cycle time (read) (write)		170 130	-	nS
t _{PWR68}	WR1	Pulse width (read)		85	ı	nS
t _{PWW68}		Pulse width (write)		65	-	nS
t _{LPW68}		Low pulse width (read) (write)		85 65	-	nS
t _{DS68} t _{DH68}	D0~D7	Data setup time Data hold time		30 0	-	nS
taccss t _{oh68}		Read access time Output disable time	C _L = 100pF		70 30	nS
tcssa68 tcsh68	CS1/CS0	Chip select setup time Chip select hold time		5		nS

RESET TIMING

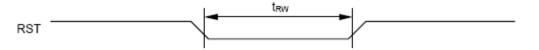


FIGURE 17: Reset Characteristics

 $(1.65V \le V_{DD} \le 3.3V, Ta = -30 \text{ to } +85^{\circ}C)$

Symbol	Signal	Description	Condition	Min.	Max.	Units
t _{RW}	RST	Reset low pulse width		3	1	μS
t _{RD}	RST, WR	Reset to WR pulse delay		10	-	mS

9. CONTROL AND DISPLAY INSTRUCTION

The following is a list of host commands supported by UC1617w

C/D: 0: Control, 1: Data W/R: 0: Write Cycle, 1: Read Cycle

Useful Data bits
- Don't Care

	Command	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Action	Default
1	Write Data Byte	1	0	#	#	#	#	#	#	#	#	Write 1 byte	N/A
2	Read Data Byte	1	1	#	#	#	#	#	#	#	#	Read 1 byte	N/A
3	Get Status	0	1	_	MX er	MY	WA		WS [5:0]	MD	MS	Get (Status, Ver, PMO, Product Code, PID, MID)	N/A
⊢			_		roduc		_	_	ID	. М	-		
4	Set Page_C Address	0	0	0	0	0	#	#	#	#	#	Set CA[4:0]	0H
5	Set Temp. Compensation	0	0	0	0	1	0	0	1	#	#	Set TC[1:0]	d00
6	Set Panel Loading	0	0	0	0	1	0	1	0	#	#	Set PC[1:0]	10b
7	Set Pump Control	0	0	0	0	1	0	1	1	#	#	Set PC[3:2]	11b
8	Set Adv. Program Control (double-byte command)	0	0	0 #	0 #	1 #	1 #	0 #	0 #	R #	R #	Set APC[R][7:0], R = 0, 1 or 2	N/A
⊢	Set Scroll Line LSB	0	0	0	1	0	0	#	#	#	#	,	OH
9		0	0		_	0		#	#	#	#	Set SL[3:0]	
⊢	Set Scroll Line MSB Set Row Address LSB	0	0	0	1	1	1 0	#	#	#	#	Set SL[6:4]	0H 00H
10					-				#	#	#	Set RA[3:0]	
⊢	Set Row Address MSB	0	0	1	1	1	1 0	-		0		Set RA[6:4]	00H
11	Set V _{BIAS} Potentiometer (double-byte command)	0	0	1 #	0 #	#	#	0 #	0 #	#	1 #	Set PM[7:0]	4EH
12	Set Partial Display Control	0	0	1	0	0	0	0	1	#	#	Set LC[9:8]	00b: Disable
13	Set RAM Address Control	0	0	1	0	0	0	1	#	#	#	Set AC[2:0]	001b
14	Set Fixed Lines	0	0	1 #	0 #	0	1 #	0	0	0	0 #	Set (FLT, FLB)	0
15	Set Line Rate	0	0	1	0	1	0	0	0	#	#	Set LC[4:3]	00b
16	Set All-Pixel-ON	0	0	1	0	1	0	0	1	0	#	Set DC[1]	0b
17	Set Inverse Display	0	0	1	0	1	0	0	1	1	#	Set DC[0]	0b
18	Set Display Enable	0	0	1	0	1	0	1	1	#	#	Set DC[3:2]	10b
19	Set LCD Mapping Control	0	0	1	1	0	0	0	#	#	#	Set LC[2:0]	d000
20	Set N-Line Inversion	0	0	1	1	0	0	1 #	0	0	0 #	Set NIV[3:0]	6H
21	Set LCD Gray Shade	0	0	1	1	0	1	0	#	#	#	Set LC[7:5]	001b
22	System Reset	0	0	1	1	1	0	0	0	1	0	System Reset	N/A
23	NOP	0	0	1	1	1	0	0	0	1	1	No operation	N/A
24	Set Test Control	0	0	1	1	1	0	0	1		Т	For testing only.	N/A
0.5	(double-byte command)	0	0	#	#	#	#	#	#	#	#	Do not use.	441
25	Set LCD Bias Ratio	0	0	1	1	1	0	1	0	#	#	Set BR[1:0]	11b: 11
26	Reset Cursor Update Mode	0	0	1	1	1	0	1	1	1	0	AC[3]=0, CA=CR	AC[3]=0
27	Set Cursor Update Mode	0	0	1	1	1	0	1	1	1	1	AC[3]=1, CR=CA	AC[3]=1
28	Set COM End	0	0	1	1 #	1 #	1 #	0 #	0 #	0 #	1 #	Set CEN[6:0]	127
29	Set Partial Display Start	00	0	1 -	1 #	1 #	1 #	0	0	1 #	0 #	Set DST[6:0]	0
30	Set Partial Display End	0 0	0	1	1 #	1 #	1 #	0 #	0 #	1 #	1 #	Set DEN[6:0]	127

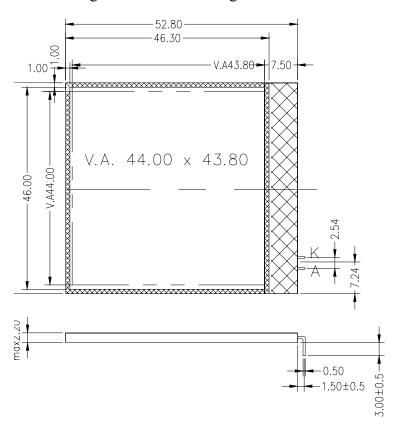
	Command	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Actio	n	Default	
31	Set Window Program Starting Page_C Address	0	0 0	1	1	1	1 #	0	1 #	0 #	0		Set WPC0	0	
32	Set Window Programming Starting Row Address	0 0	0	1	1 #	1 #	1 #	0	1 #	0	1 #	Shared with MTP commands	Set WPP0	0	
33	Set Window Programming Ending Page_C Address	0 0	0	1 -	1	1	1 #	0	1 #	1 #	0			Set WPC1	31
34	Set Window Programming Ending Row Address	00	0 0	1 -	1 #	1 #	1 #	0	1 #	1 #	1 #		Set WPP1	127	
35	Enable window program	0	0	1	1	1	1	1	0	0	#	Set AC[4]		0: Disable	
36	Set MTP Operation control	0 0	0 0	1	0	1 #	1 #	1 #	0	0	0	Set MTP0	Set MTPC[5:0]		
37	Set MTP Write Mask	0 0	0 0	1 #	0	1 #	1 #	1 #	0	0	1 #	Set MTPN	Λ[7:0]	0	
38	Set V _{M™P1} Potentiometer	0	0	1 #	1 #	1 #	1 #	0	1 #	0	0		Set MTP1		
39	Set V _{MTP2} Potentiometer	0 0	0 0	1 #	1 #	1 #	1 #	0	1 #	0	1 #	Shared with Window	Set MTP2	N/A	
40	Set MTP Write Timer	00	0 0	1 #	1 #	1 #	1 #	0	1 #	1 #	0 #	Program commands	Set MTP3		
41	Set MTP Read Timer	00	0	1 #	1 #	1	1	0 #	1	1 #	1 #	oon mile ide	Set MTP4		

Notes:

- Any bit patterns other than the commands listed above may result in undefined behavior.
- The interpretation of commands (37)~(41) depends on register MTPC[3].
- Commands (38)~(41) are shared with commands (31)~(34) and have exactly the same code.
 When MTPC[3]=0, commands (38)~(41) are interpreted as Window Programming commands.
 When MTPC[3]=1, they are the MTP Control commands.
- MTPM and PM are actually the same register. Only one of the commands (37 or 11) is valid at any time, and it is determined by MTPC[3].
- After MTP-ERASE or MTP-PROGRAM operation, before resuming normal operation, please always a) Remove TST4 power source,
 - b) Do a full VDD ON-OFF-ON cycle.

10. BACK LIGHT CHARACTERISTICS

LCD Module with Edge white LED Backlight



ELECTRICAL RATINGS.

 $Ta = 25^{\circ}C$

Item	Symbol	Condition	Min	Тур	Max	Unit	
Forward Volatge	VF	IF=45mA	2.9	3.1	3.3	V	
Reverse Current	IR	VR=5.0V		20		mA	
Luminous Intensity(Without LCD)	Lv	IF=45mA	300	350		cd/m2	
Color coordinates		IF=45mA	X=0.26 Y=0.26		X=0.30 Y=0.30		
Color	white						

Note:

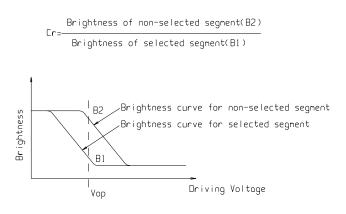
when the temperature exceed 25° C, the approved current decrease rate for Backlight change as the temperature increase is: $-0.36x3mA/^{\circ}$ C (below 25° C, the current refer to constant, which would not change with temperature).

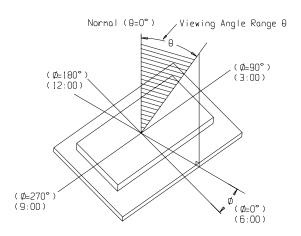
11. ELECTRO-OPTICAL CHARACTERISTICS

 $\overline{(V_{DD} = 3.3V, Ta = 25^{\circ}C)}$

Item	Symbol	Condition	Min	Тур	Max	Unit
Operating Voltage for LCD	Vop	$Ta = -20^{\circ}C$	11.7	12.0	12.3	V
		$Ta = 25^{\circ}C$	11.2	11.5	11.8	
		$Ta = 70^{\circ}C$	10.7	11.0	11.3	
Response time	Tr	Ta = 25°C		250	500	ms
	Tf			300	600	ms
Contrast	Cr	$Ta = 25^{\circ}C$	2	4		
Viewing angle range	θ	Cr≥2	-35		+35	deg
	Ф		-35		+40	deg

The following charts is for your reference of the data in the above form.





12. PRECAUTION FOR USING LCD/LCM

After reliability test, recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours (average) under ordinary operating and storage conditions room temperature (20±8°C), normal humidity (below 65% RH), and in the area not exposed to direct sun light. Using LCM beyond these conditions will shorten the life time.

Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not make any modification on the PCB without consulting DISPLAY.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: $350^{\circ}\text{C} \pm 10^{\circ}\text{C}$
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

DISPLAY LCDs and modules are not consumer products, but may be incorporated by DISPLAY's customers into consumer products or components thereof, DISPLAY does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of DISPLAY is limited to repair or replacement on the terms set forth below. DISPLAY will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between DISPLAY and the customer, DISPLAY will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with DISPLAY general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.